

Wide Band Low Noise Amplifier 0.01GHz-50GHz



Product Description

RLNA00M50GB is a wide band low noise amplifier with a frequency range of 0.01 to 50GHz.

The power output of this amplifier is 20dBm typical. The typical gain is 16dB with a gain flatness of $\pm 2.5 \text{dB}.$

The working temperature of this product is between -40 °C and +85 °C.

Features

- Wide Band Low Noise Amplifier
- Gain 16dB Typical
- Output Saturation Power 20dBm Typical
- Supply Voltage +8VDC
- 50 Ohm Matched Input/Output
- Low Noise Figure +5dB Typical
- Gain Flatness ± 2.5 dB

Typical Applications

- Wireless Infrastructure
- Military and Aerospace Applications
- Test Instrumentation
- Radar Systems
- 5G Wireless Communications
- Microwave Radio Systems
- TR Modules
- Research and Development
- Cellular Base Stations

Parameter	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Units	
Frequency Range	0.01		20	20		40	40		50	GHz	
Gain	14	16		13	15		7	13		dB	
Gain Flatness		±3.0			±1.5			±3.0		dB	
Gain Variation Over Temperature (-40°C~+85°C)		±1.5			±1.5			±1.5		dB	
Noise Figure		5			7			8		dB	
Input VSWR		1.5	2.0		1.8	2.5		1.8	2.5	: 1	
Output VSWR		1.5	3.0		2.0	2.5		2.0	2.8	: 1	
Output 1dB Compression Point (P1dB) 19	20		16	17		10	14		dBm	
Saturated Output Power (Psat)		23			20			16		dBm	
Output Third Order Intercept (OIP3)		32			28			25		dBm	
Supply Current (Vcc=+8V)		210	300		210	300		210	300	mA	
Isolation S12		-50			-40			-38		dB	
Net					0.042 Max					llee	
Weight Including Heat Sink					0.159 Max					lbs.	
Impedance					50					Ohms	
Input / Output Connectors		2.4mm-Female(Input)-2.4mm-Female(Output)									
Deskere		Epoxy Sealed (Standard)									
Package		Hermetically Sealed (Optional)									



RLNA00M50GB

Absolute Maximum Ratings

Parameter	Rating
Operating Voltage	+10.5VDC
*RF Input Power (RFIN)	+15dBm

Bias Up Procedure

Bias Down Procedure

1. Connect ground

2. Connect input and output with 50 Ohm source/load. (In band VSWR < 1.9:1 or >10dB return loss.)

3. Connect positive supply and make sure power supply can handle max current.

1. Turn off power supply and remove positive supply

2. Disconnect input and output with 50 Ohm source/load. (In band VSWR < 1.9:1 or >10dB return loss.)

3. Remove ground

Environmental Specifications and Test Standards

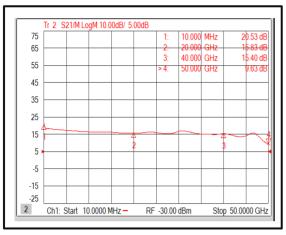
Parameter	Description
Operational Temperature	-40°C to +85°C (Case Temperature)
Storage Temperature	-50°C to +105°C
Thermal Shock	-40°C → +85°C (5 Cycles / 10 hours)
**Random Vibration	MIL-STD-202G Table 214-I, Test Condition Letter C 1.5 Hours Per Axis
High Temperature Burn In	Temperature +85°C for 72 Hours
Shock	 Weight >20g, 50g half sine wave for 11ms, Speed variation 3.44m/s Weight <=20g, 100g Half sine wave for 6ms, Speed variation 3.75m/s Total 18 times (6 directions, 3 repetitions per direction).
Altitude	Standard: 30,000 Ft (Epoxy Sealed Controlled Environment) Optional: Hermetically Sealed (60,000 ft. 1.0 PSI min)
Hermetically Sealed (Optional)	MIL-STD-883 (For Hermetically Sealed Units)

*Maximum RF input power is set to assure safety of amplifier. Input power may be increased at own risk to achieve full power of amplifier. Please reference gain and power curves.

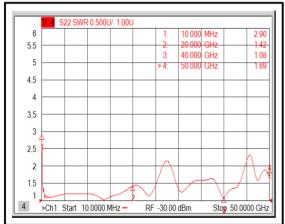
**For vibration testing details please see additional information section.



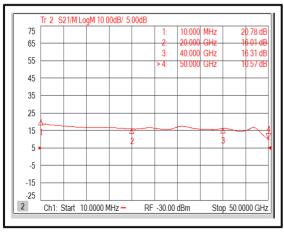
Gain@+25℃



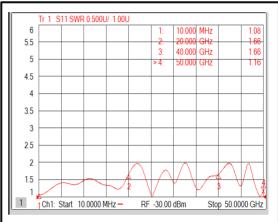
Output VSWR@+25°C



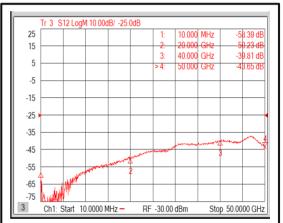
Gain@-40°C



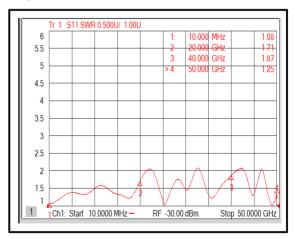
Input VSWR@+25°C



Isolation@+25°C

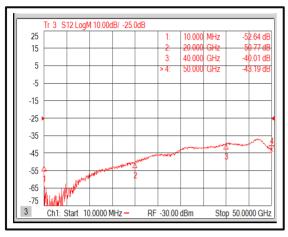


Input VSWR@-40°C

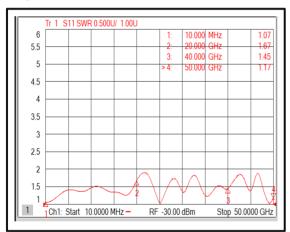




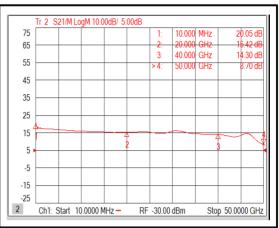
Isolation@-40°C



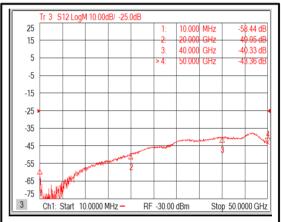
Input VSWR@+85°C



Gain@+85°C





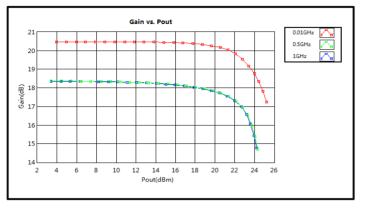


RLNA00M50GB

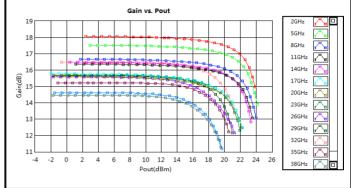


RLNA00M50GB

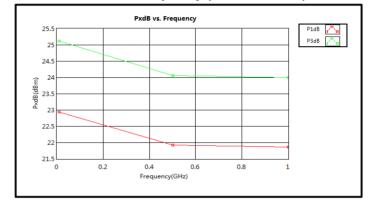
Gain vs. Output Power (0.01GHz-1GHz)



Gain vs. Output Power (2GHz-39GHz)

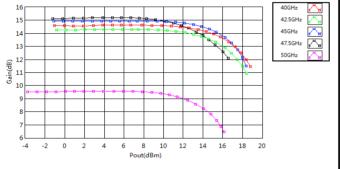


P1dB & P3dB vs. Frequency (0.01GHz-1GHz)

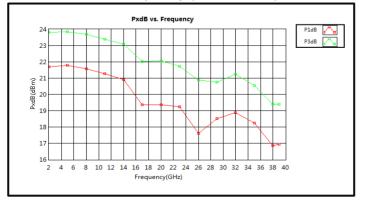


Gain vs. Pout 16 40GH 15 45GHz 14 13

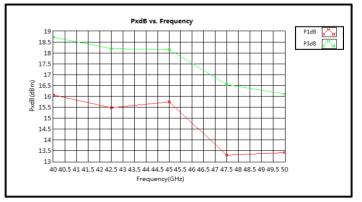
Gain vs. Output Power (40GHz-50GHz)



P1dB & P3dB vs. Frequency (2GHz-40GHz)



P1dB & P3dB vs. Frequency (40GHz-50GHz)

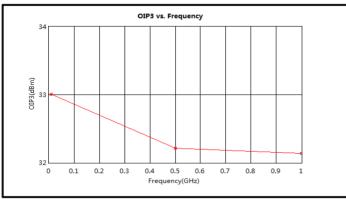


RLNA00M50GB

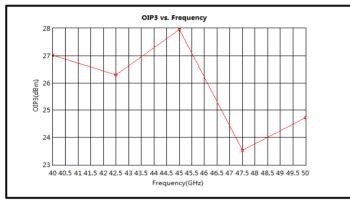


Typical Performance Plots

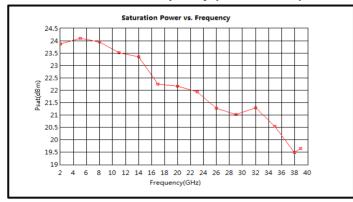
Output Third Order Intercept (OIP3) (0.01GHz-1GHz)



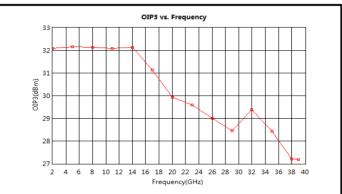
Output Third Order Intercept (OIP3) (40GHz-50GHz)



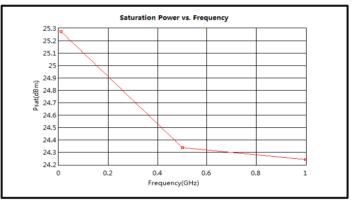
Saturation Power vs. Frequency (2GHz-40GHz)



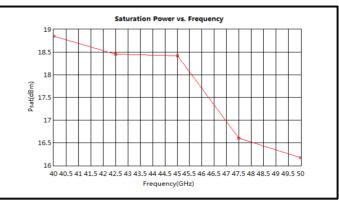
Output Third Order Intercept (OIP3) (2GHz-40GHz)



Saturation Power vs. Frequency (0.01GHz-1GHz)



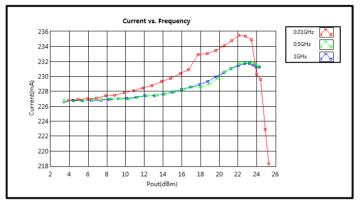
Saturation Power vs. Frequency (40GHz-50GHz)

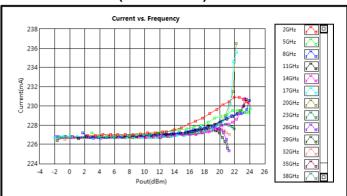




RLNA00M50GB

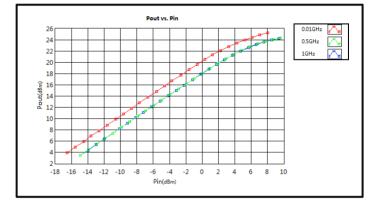
Current vs. Pout (0.01GHz-1GHz)



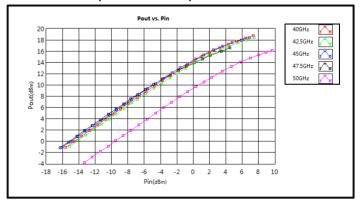


Current vs. Pout (2GHz-39GHz)

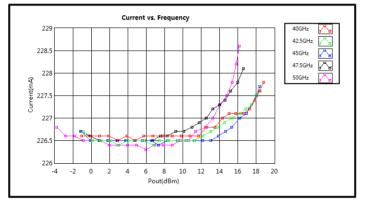
Pout vs. Pin (0.01GHz-1GHz)



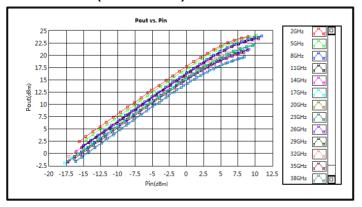
Pout vs. Pin (40GHz-50GHz)



Current vs. Pout (40GHz-50GHz)



Pout vs. Pin (2GHz-39GHz)

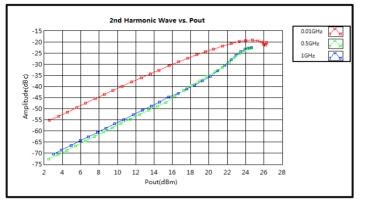




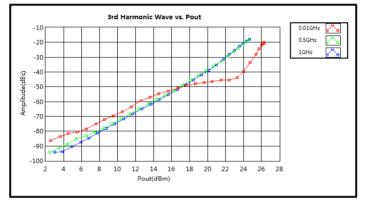
RLNA00M50GB

Typical Performance Plots

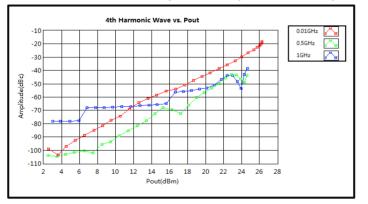
2nd Harmonic Wave Output Power (0.01GHz-1GHz)

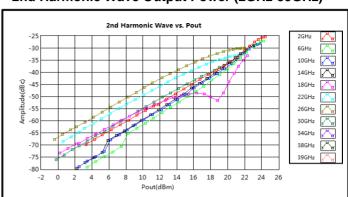


3rd Harmonic Wave Output Power (0.01GHz-1GHz)



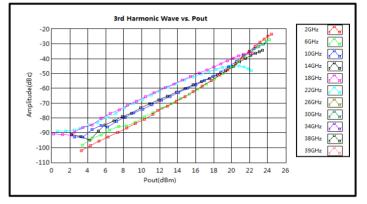
4th Harmonic Wave Output Power (0.01GHz-1GHz)

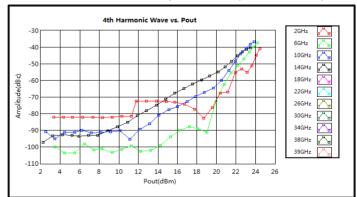




2nd Harmonic Wave Output Power (2GHz-39GHz)

3rd Harmonic Wave Output Power (2GHz-39GHz)



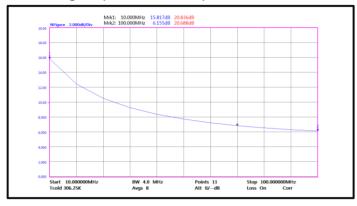


4th Harmonic Wave Output Power (2GHz-39GHz)

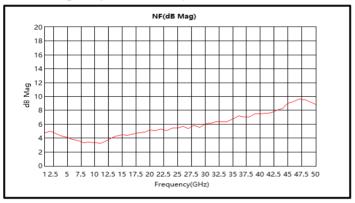


RLNA00M50GB

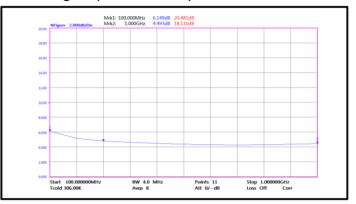
Noise Figure (10MHz-100MHz)



Noise Figure (1GHz-50GHz)



Noise Figure (100MHz-1GHz)



RF-LAMBD ADER OF REBROADBAND SOLUTIONS

пт

Outline Drawing

14.35 [0.56]

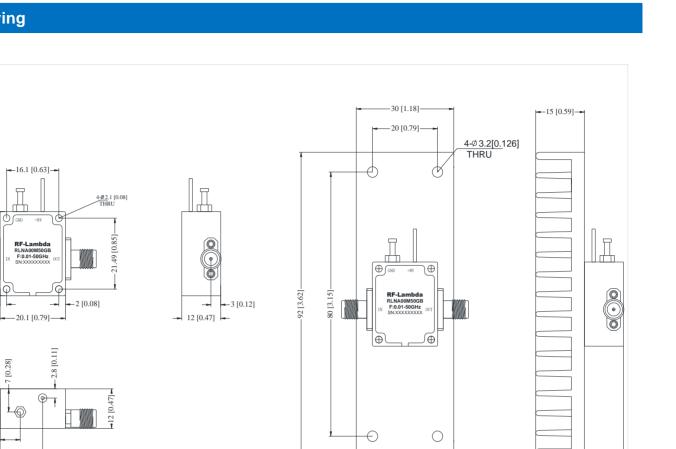
+ 9 [0.35]

2 [0.08]-

6.2 [0.24]

[0.28]

25.5 [1.00]



Including Heat

sink

Notes:

- Package Material: Aluminum. 1.
- Finish: Gold Plated. 2.
- All dimensions are in millimeters [inches]. 3.
- 4. Housing Tolerances ± 0.1 [0.004] to ± 0.2 [0.008] unless otherwise specified(Excl Heat Sink).
- Heat sink required during operation (sold separately). Matching heatsink is listed on our website. 5. If customer would like to use their own cooling method, please make sure the amplifier will operate under the specs that listed in page 2 of this datasheet.
- Standard torque wrench must be used to secure RF connectors. 6.

Additional Information

Documentation	Webpage	
ESD Policy	https://rflambda.com/pdf/rflambda_esd_control.pdf	
Heatsink Lookup Specifications	https://rflambda.com/search_heatsink.jsp	
Connector Torque Specifications	https://www.rflambda.com/pdf/Torque_Specifications.pdf	
Random Vibration Test Standard	https://www.rflambda.com/pdf/rflambda_random_vibration_MIL-STD-202G.pdf	

RLNA00M50GB

RF-LAMBDA USA LLC: www.rflambda.com Sales: sales@rflambda.com Technical: support@rflambda.com



-27 [1.06]-



Ordering Information

Part Number	Modification	Description
RLNA00M50GB	Connectors 2.4mm-Female	0.01GHz-50GHz Low Noise Amplifier

Amplifier Use

Ensure that the amplifier input and output ports are safely terminated into a proper 50 ohm load before turning on the power. Never operate the amplifier without a load. A proper 50 ohm load is defined as a load with impedance less than 1.9:1 or return loss larger than 10dB relative to 50 Ohm within the specified operating band width.

Power Supply Requirements

Power supply must be able to provide adequate current for the amplifier. Power supply should be able to provide 1.5 times the typical current or 1.2 times the maximum current (whichever is greater).

In most cases, RF - Lambda amplifiers will withstand severe mismatches without damage. However, operation with poor loads is discouraged. If prolonged operation with poor or unknown loads is expected, an external device such as an isolator or circulator should be used to protect the amplifier.

Ensure that the power is off when connecting or disconnecting the input or output of the amp.

Prevent overdriving the amplifier. Do not exceed the recommended input power level.

Adequate heat-sinking required for RF amplifier modules. Please inquire.

Amplifiers do not contain Thermal protection, Reverse DC polarity or Over voltage protection with the exception of a few models. Please inquire.

Proper electrostatic discharge (ESD) precautions are recommended to avoid performance degradation or loss of functionality.

What is not covered with warranty?

Each RF - Lambda amplifier will go through power and temperature stress testing. Since the die, ICs or MMICs are fragile, these are not covered by warranty. Any damage to these will NOT be free to repair.

Important Notice

The information contained herein is believed to be reliable. RF-Lambda makes no warranties regarding the information contained herein. RF-Lambda assumes no responsibility or liability whatsoever for any of the information contained herein. RF-Lambda assumes no responsibility or liability whatsoever for the use of the information contained herein. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the user. All information contained herein is subject to change without notice. Customers should obtain and verify the latest relevant information before placing orders for RF-Lambda products. The information contained herein or any use of such information does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other intellectual property rights, whether with regard to such information itself or anything described by such information.

RF-Lambda products are not warranted or authorized for use as critical components in medical, life-saving, or life sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death.